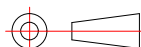
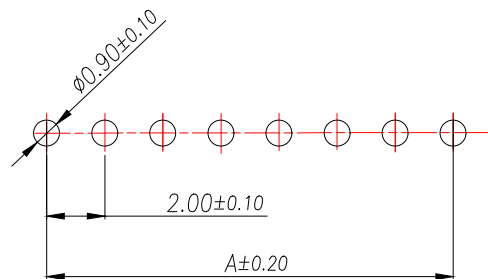


Part No	PIN	A	B
WF-PH2.0-2PZZ	2	2	6
WF-PH2.0-3PZZ	3	4	8
WF-PH2.0-4PZZ	4	6	10
WF-PH2.0-5PZZ	5	8	12
WF-PH2.0-6PZZ	6	10	14
WF-PH2.0-7PZZ	7	12	16
WF-PH2.0-8PZZ	8	14	18
WF-PH2.0-9PZZ	9	16	20
WF-PH2.0-10PZZ	10	18	22
WF-PH2.0-11PZZ	11	20	24
WF-PH2.0-12PZZ	12	22	26
WF-PH2.0-13PZZ	13	24	28
.....	...	...	...
WF-PH2.0-20PZZ	20	$(20-1)*2$	$(20+1)*2$

- 技术要求:
- 1、塑料材料:PA66 (UL-94V-0)
- 2、接触件:黄铜镀锡
- 3、接触电阻: $\leq 10\text{m}\Omega$
- 4、绝缘电阻: $\geq 1000\text{M}\Omega$
- 5、额定电压:250V AC DC
- 6、额定电流:2.0A AC DC
- 7、耐压:能承受1000V AC/Minute
- 8、工作温度: $-25^{\circ}\sim +85^{\circ}$
- 9、可焊性试验:浸锡面积 $\geq 95\%$ 温度 $220 \pm 5^{\circ}$, 时间 2.5 ± 0.5 秒
- 10、铅和镉等六大有害物质含量要符合环保要求

GENERAL TOLERANCE		DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD					BXCONN [®]	
DIM. TOL. X X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 GENERAL ANGLE: ±3°		TITLE: <i>WAFER 2.0mm H6.0mm 180° DIP</i>						
DWG. NO.: <i>WF-PH2.0-XPZZ</i>					DRAWN: MAX			
PART NO.: <i>WF-PH2.0-XPZZ</i>					CHECKED: ELLA			
		UNIT: mm	SCALE: none	SHEET: 1 of 1	DWG. SIZE: A4	LAYER: bxconn	APPROVED: WILL	



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)